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QN4103M6N

N-Channel 40V Fast Switching MOSFET

General Description

The QN4103M6N is the highest performance trench N-Channel MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The QN4103M6N meet the RoHS and Green Product requirement with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Green Device Available

Product Summary

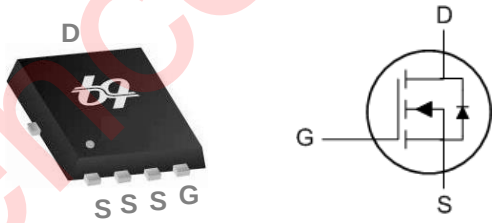
Green RoHS、HF、Pb

BVDSS	RDSON (VGS=10V)	ID (TC=25℃)
40V	1.4mΩ	255A

Applications

- Synchronous rectifier for Consumer/Computing /Industry Power Supply
- Motor
- Load Switch

PRPAK 5X6 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	40	V
V_{GS}	Gate-Source Voltage	±20	V
I_D@T_C=25℃	Continuous Drain Current, V_{GS} @ 10V[1]	255	A
I_D@T_C=100℃	Continuous Drain Current, V_{GS} @ 10V[1]	161	A
I_D@T_A=25℃	Continuous Drain Current, V_{GS} @ 10V[1]	31	A
I_D@T_A=70℃	Continuous Drain Current, V_{GS} @ 10V[1]	24	A
I_{DM}	Pulsed Drain Current[2]	510	A
EAS	Single Pulse Avalanche Energy[3]	1024.0	mJ
I_{AS}	Avalanche Current	64.0	A
P_D@T_C=25℃	Total Power Dissipation[4]	156	W
P_D@T_A=25℃	Total Power Dissipation[4]	2.3	W
T_{STG}	Storage Temperature Range	-55 to 150	℃
T_J	Operating Junction Temperature Range	-55 to 150	℃

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient[1]	43	54	℃/W
$R_{\theta JC}$	Thermal Resistance Junction-Case	0.6	0.8	℃/W

Electrical Characteristics (T_J=25 ℃, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V , I_D=250uA	40	---	---	V
$\triangle BV_{DSS}/\triangle T_J$	BVDSS Temperature Coefficient	Reference to 25℃ , I_D=1mA	---	0.025	---	V/℃
$R_{DS(ON)}$	Static Drain-Source On-Resistance[2]	V_{GS}=10V , I_D=50A	---	1.1	1.4	mΩ
		V_{GS}=4.5V , I_D=30A	---	1.5	2.0	
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS}=V_{DS} , I_D =250uA	1.2	---	2.5	V
$\triangle V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient		---	-5.2	---	mV/℃
I_{DSS}	Drain-Source Leakage Current	V_{DS}=32V , V_{GS}=0V , T_J=25℃	---	---	1	uA
		V_{DS}=32V , V_{GS}=0V , T_J=55℃	---	---	5	
I_{GSS}	Gate-Source Leakage Current	V_{GS}=±20V , V_{DS}=0V	---	---	±100	nA
gfs	Forward Transconductance	V_{DS}=5V , I_D=30A	---	94.2	---	S
R_g	Gate Resistance	V_{DS}=0V , V_{GS}=0V , f=1MHz	---	0.9	---	Ω
Q_g	Total Gate Charge (10V)	V_{DS}=20V , V_{GS}=10V , I_D=30A	---	73.7	---	nC
Q_g	Total Gate Charge (4.5V)	V_{DS}=20V , V_{GS}=4.5V , I_D=30A	---	32.9	---	
Q_{gs}	Gate-Source Charge		---	16.3	---	
Q_{gd}	Gate-Drain Charge		---	7.2	---	
$T_{d(on)}$	Turn-On Delay Time	V_{DD}=20V , V_{GS}=10V , R_G=3.3Ω I_D=30A	---	15.2	---	ns
T_r	Rise Time		---	45.2	---	
$T_{d(off)}$	Turn-Off Delay Time		---	53.0	---	
T_f	Fall Time		---	7.2	---	
C_{iss}	Input Capacitance	V_{DS}=20V , V_{GS}=0V , f=1MHz	---	5450	---	pF
C_{oss}	Output Capacitance		---	996	---	
C_{rss}	Reverse Transfer Capacitance		---	35	---	

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
EAS	Single Pulse Avalanche Energy[5]	V_{DD}=50V , L=0.5mH , I_{AS}= 46A	529	---	---	mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current[1,6]	V_G=V_D=0V , Force Current	---	---	255	A
I_{SM}	Pulsed Source Current[2,6]		---	---	510	A
V_{SD}	Diode Forward Voltage[2]	V_{GS}=0V , I_S=1A , T_J=25℃	---	---	1.2	V
trr	Reverse Recovery Time	IF=30A , di/dt=100A/μs , T_J=25℃	---	44	---	nS
Qrr	Reverse Recovery Charge		---	50	---	nC

Note :
1.The data tested by surface mounted on a 1 inch^2 FR-4 board with 2OZ copper.
2.The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%
3.The EAS data shows Max. rating . The test condition is V_{DD}=50V,V_{GS}=10V,L=0.5mH
4.The power dissipation is limited by 150℃ junction temperature
5.The Min. value is 100% EAS tested guarantee.
6.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

Typical Characteristics

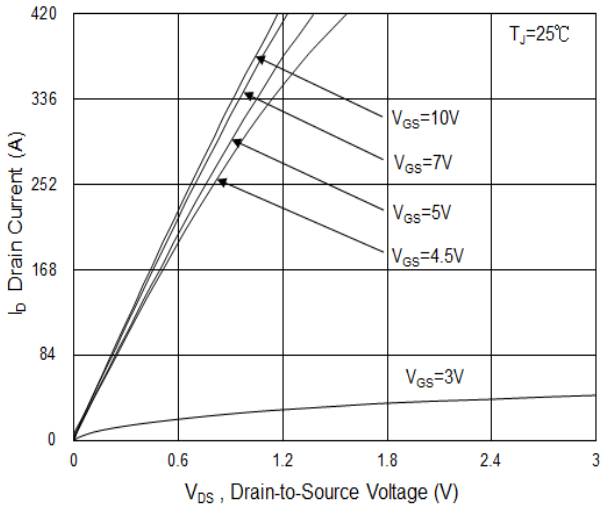


Fig.1 Typical Output Characteristics

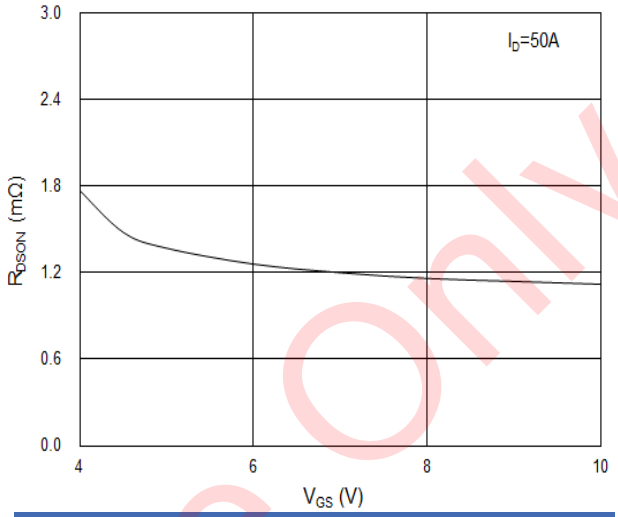


Fig.2 On-Resistance vs. Gate-Source

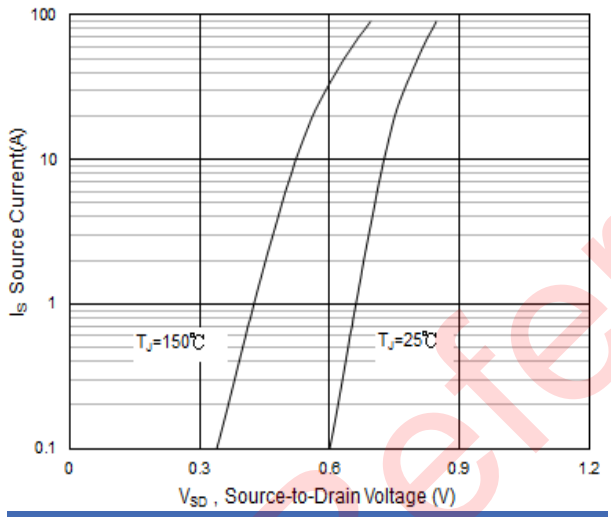


Fig.3 Forward Characteristics of Reverse

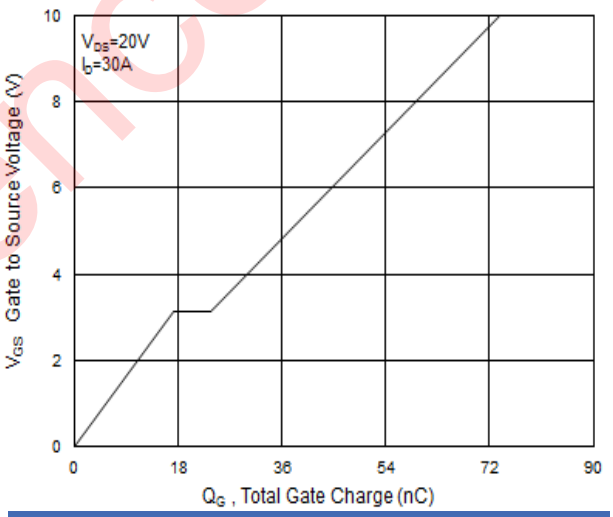


Fig.4 Gate-Charge Characteristics

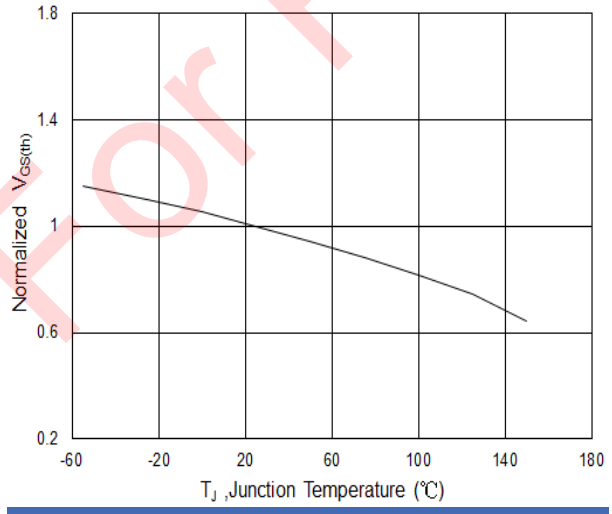


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

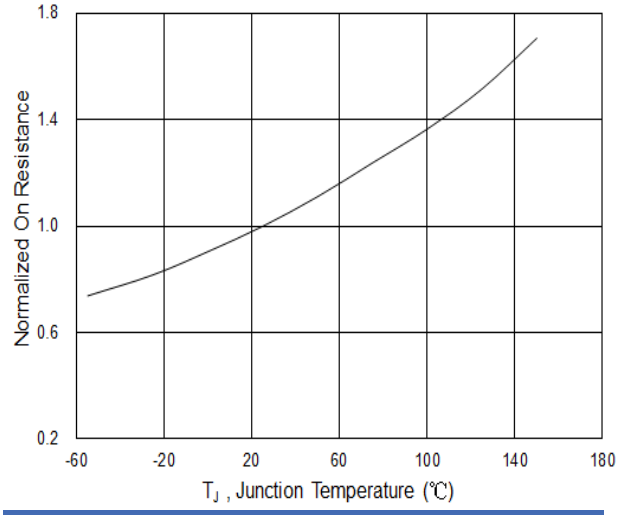


Fig.6 Normalized R_{DSON} vs. T_J

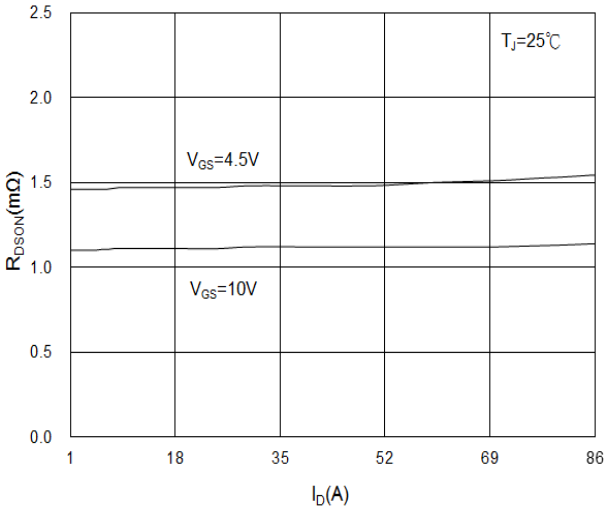


Fig.7 Drain-Source On-State Resistance

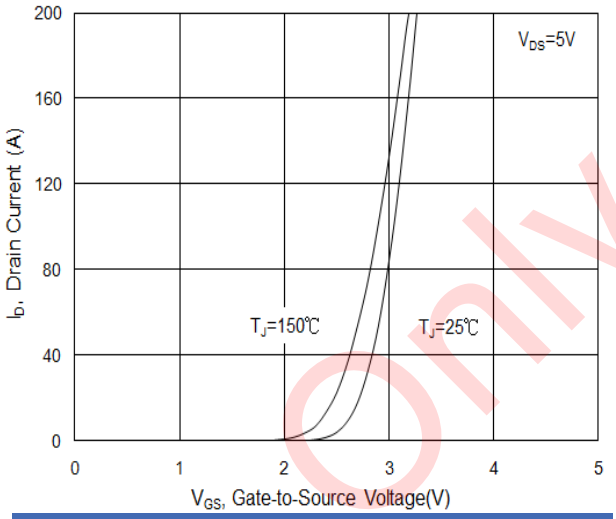


Fig.8 Transfer Characteristics

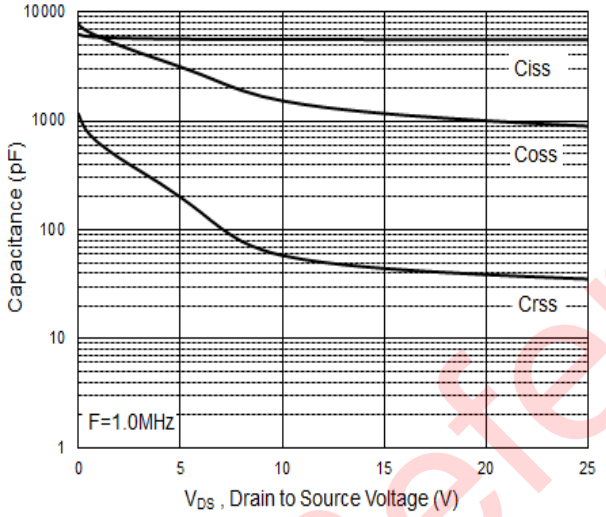


Fig.9 Capacitance

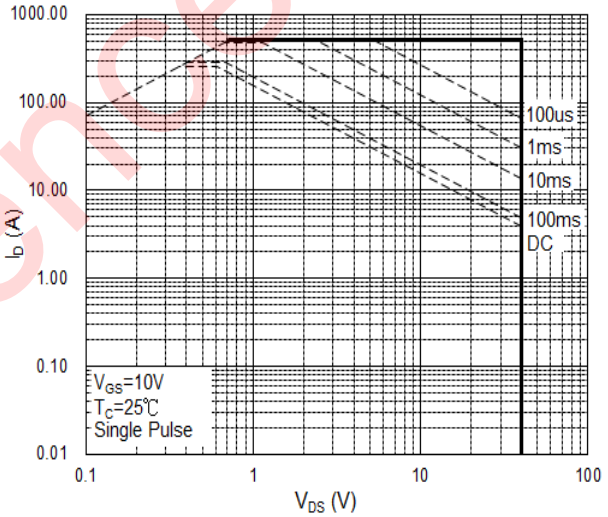


Fig.10 Safe Operating Area

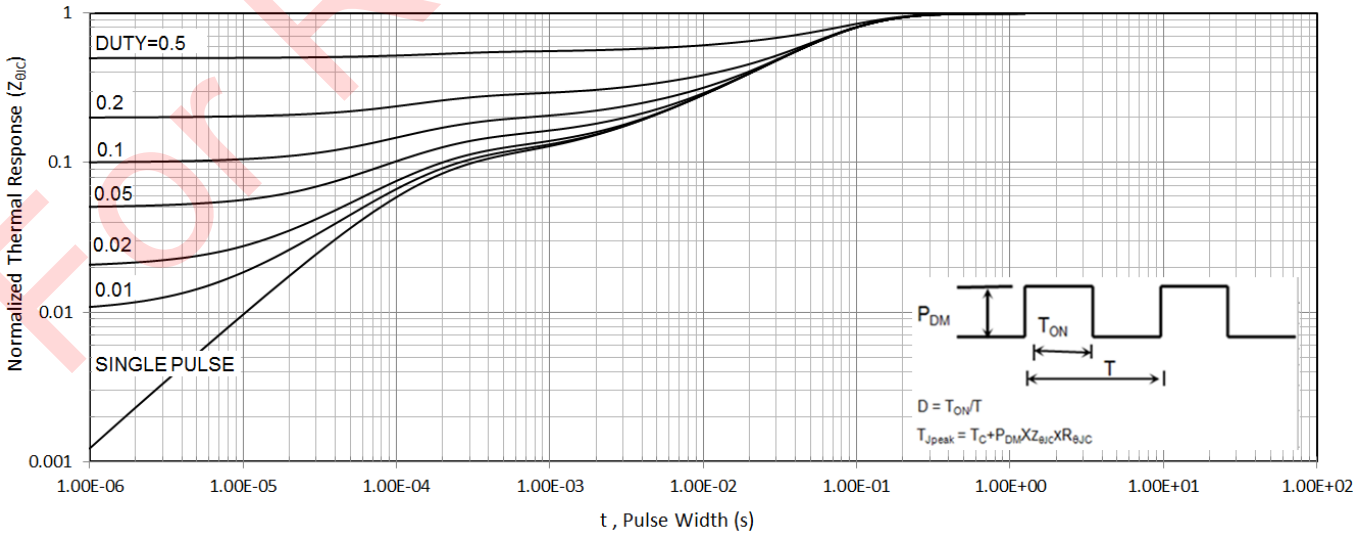
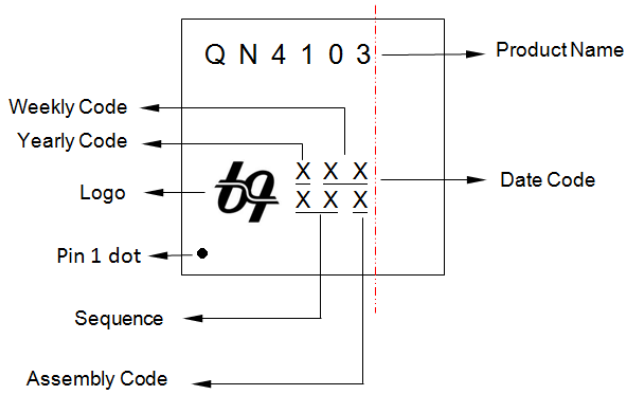


Fig.11 Transient Thermal Impedance

Top Marking



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